AUTOMOTIVE GRADE

ROHS

HALOGEN FREE



Vishay General Semiconductor

High Current Density Surface Mount MOS Barrier Schottky Rectifier Ultra Low

 $V_F = 0.453 \text{ V at } I_F = 5 \text{ A}$

TMBS® eSMP® Series



TO-277A (SMPC)



PRIMARY CHARACTERISTICS				
I _{F(AV)}	10 A			
V_{RRM}	100 V			
I _{FSM}	180 A			
E _{AS}	100 mJ			
V _F at I _F = 10 A	0.574 V			
T _J max.	150 °C			
Package	TO-277A (SMPC)			
Diode variations Single die				

TYPICAL APPLICATIONS

For use in low voltage high frequency inverters, freewheeling, DC/DC converters, and polarity protection applications.

FEATURES

- Very low profile typical height of 1.1 mm
- Ideal for automated placement
- Trench MOS Schottky technology
- Low forward voltage drop, low power losses
- High efficiency operation
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
 - Automotive ordering code; base P/NHM3
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

MECHANICAL DATA

Case: TO-277A (SMPC)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Base P/NHM3 - halogen-free, RoHS-compliant and AEC-Q101 qualified

Base P/NHM3_X - halogen-free, RoHS-compliant and AEC-Q101 qualified

("_X" denotes revision code e.g. A, B,....)

Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 1A whisker test, HM3 suffix meets JESD 201 class 2 whisker test

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)					
PARAMETER	SYMBOL	V10P10	UNIT		
Device marking code		V1010			
Maximum repetitive peak reverse voltage	V_{RRM}	100	V		
Maximum average forward rectified current (fig. 1)	I _{F(AV)} 10		Α		
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I _{FSM}	180	А		
Non-repetitive avalanche energy at I _{AS} = 2.0 A, T _J = 25 °C	E _{AS} 100		mJ		
Peak repetitive reverse current at t_p = 2 μ s, 1 kHz, T_J = 38 °C \pm 2 °C	I _{RRM}	1.0	A		
Operating junction and storage temperature range	T _J , T _{STG}	-40 to +150	°C		



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ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS SYMBOL		SYMBOL	TYP.	MAX.	UNIT
Breakdown voltage	I _R = 1 mA	T _A = 25 °C	V_{BR}	100 (minimum)	-	V
Instantaneous forward voltage	I _F = 5 A	——— T _∧ = 25 °C	V _F ⁽¹⁾	0.512	-	V
	I _F = 10 A			0.625	0.68	
	I _F = 5 A	T _A = 125 °C		0.453	-	
	I _F = 10 A			0.574	0.62	
Reverse current	V _R = 70 V	T _A = 25 °C	I _R ⁽²⁾	7.1	-	μΑ
	v _R = 70 v	T _A = 125 °C		4.5	-	mA
	V _R = 100 V	T _A = 25 °C		30.4	150	μΑ
	v _R = 100 v	T _A = 125 °C		10.4	20	mA

Notes

 $^{(1)}$ Pulse test: 300 μs pulse width, 1 % duty cycle

 $^{(2)}$ Pulse test: Pulse width $\leq 40 \text{ ms}$

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise specified)				
PARAMETER	V10P10	UNIT		
Typical thermal resistance	R ₀ JA (1)	60	°C/W	
	$R_{ hetaJL}$	3	G/VV	

Note

(1) Units mounted on recommended PCB 1 oz. pad layout

ORDERING INFORMATION (Example)				
PREFERRED P/N	UNIT WEIGHT (g)	PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
V10P10-M3/86A	0.10	86A	1500	7" diameter plastic tape and reel
V10P10-M3/87A	0.10	87A	6500	13" diameter plastic tape and reel
V10P10HM3/86A (1)	0.10	86A	1500	7" diameter plastic tape and reel
V10P10HM3/87A ⁽¹⁾	0.10	87A	6500	13" diameter plastic tape and reel
V10P10HM3_A/H ⁽¹⁾	0.10	Н	1500	7" diameter plastic tape and reel
V10P10HM3_A/I ⁽¹⁾	0.10	I	6500	13" diameter plastic tape and reel

Note

(1) AEC-Q101 qualified



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RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise specified)

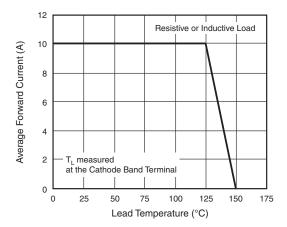


Fig. 1 - Maximum Forward Current Derating Curve

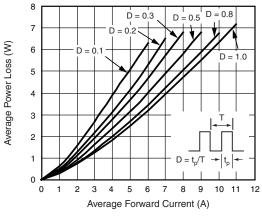


Fig. 2 - Forward Power Loss Characteristics

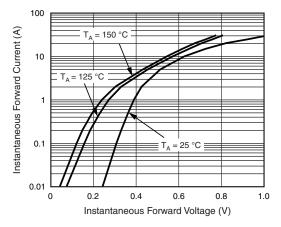


Fig. 3 - Typical Instantaneous Forward Characteristics

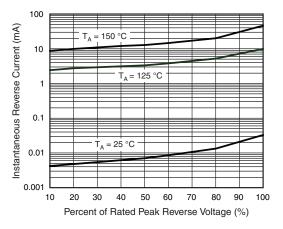


Fig. 4 - Typical Reverse Characteristics

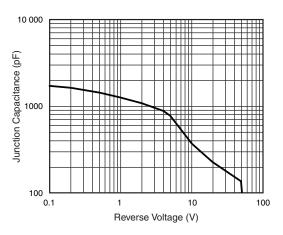


Fig. 5 - Typical Junction Capacitance

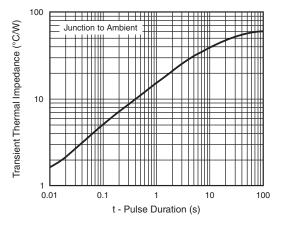
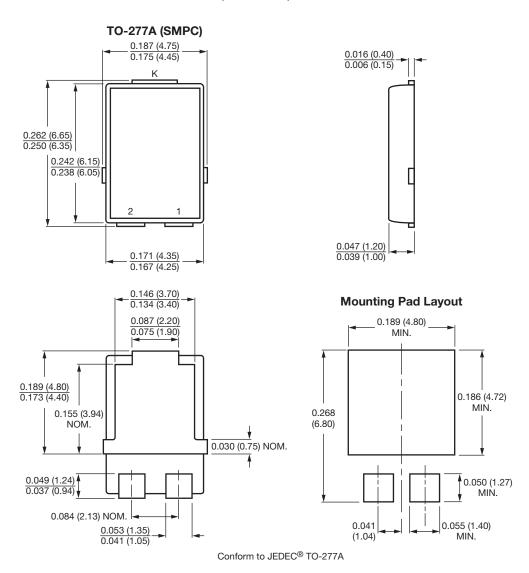


Fig. 6 - Typical Transient Thermal Impedance



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PACKAGE OUTLINE DIMENSIONS in inches (millimeters)





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